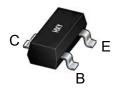


Features

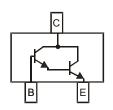
- High Collector Current
- High Current Gain



Package Marking and Ordering Information

	_		
Product ID	Pack	Marking	Qty(PCS)
BCV27	SOT-23	FF	3000
BCV47	SOT-23	FH	3000





Maxmim Ratings (Ta=25 unless otherwise noted)

Parameter		Symbol	Value	Unit	
Collector Base Voltage	BCV27	V _{CBO}	40	V	
	BCV47		80		
Collector Emitter Voltage	BCV27	V_{CEO}	30	V	
	BCV47		60		
Emitter Base Voltage		V_{EBO}	10	V	
Collector Current		Ic	500	mA	
Peak Collector Current		I _{CM}	800	mA	
Base Current		l _Β	100	mA	
Maximum Power Dissipation		P_D	200	mW	
Junction Temperature		TJ	150	°C	
Storage Temperature Range		T _{STG}	-65 to +150	°C	

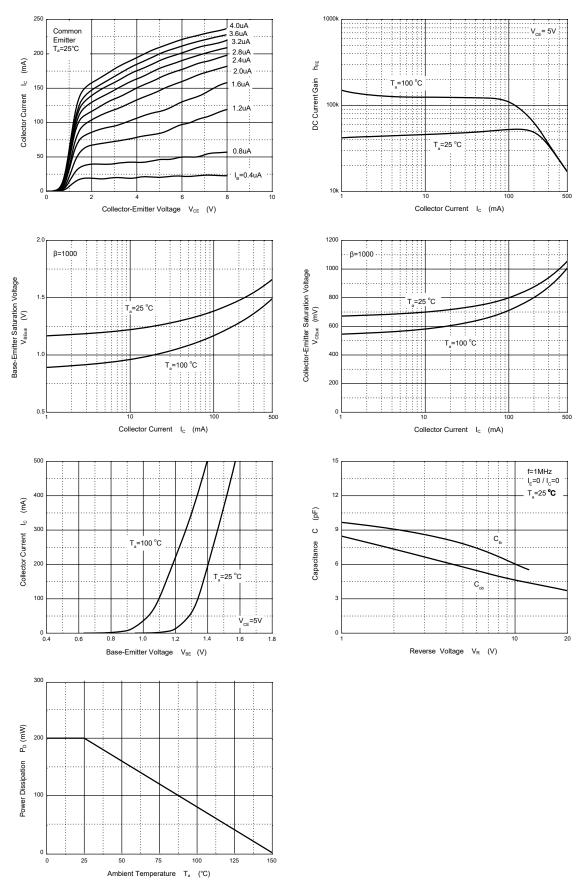


Electrcal Charcteristics (Ta=25 unless otherwise specified)

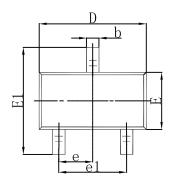
Parameter		Symbol	Min.	Тур.	Max.	Unit
DC Current Gain						
at $V_{CE} = 5 \text{ V}$, $I_C = 1 \text{ mA}$	BCV27		4000			
	BCV47		2000			
at $V_{CE} = 5 \text{ V}$, $I_C = 10 \text{ mA}$	BCV27	H_FE	10000			
	BCV47		4000			
at $V_{CE} = 5 \text{ V}$, $I_{C} = 100 \text{ mA}$	BCV27		20000			
	BCV47		10000			
Collector Base Cutoff Current						
at V _{CB} = 30V	BCV27	I _{CBO}			100	nA
at V _{CB} = 60V	BCV47				100	
Emitter Base Cutoff Current		I _{EBO}			100	nA
at V _{EB} = 10 V		IEBO			100	ПА
Collector Base Breakdown Voltage						
at I _C = 100 μA	BCV27	$V_{(BR)CBO}$	40			V
	BCV47		80			
Collector Emitter Breakdown Voltage						
at I _C = 10 mA	BCV27	$V_{(BR)CEO}$	30			V
	BCV47		60			
Emitter Base Breakdown Voltage		$V_{(BR)EBO}$	10			V
at $I_E = 10 \mu A$		V (BR)EBO	10			V
Collector Emitter Saturation Voltage		V			1	V
at I_C = 100 mA, I_B = 0.1 mA		$V_{CE(sat)}$			I	V
Base Emitter Saturation Voltage		V-=()			1.5	V
at I _C = 100 mA, I _B = 0.1 mA		$V_{BE(sat)}$			1.0	V
Base Emitter On Voltage	age	V _{BE(on)}			1.4	V
at V _{CE} = 5 V, I _C = 10 mA		V BE(on)				
Transition Frequency		F⊤		220		MHz
at V _{CE} = 5 V, I _C = 30 mA, f = 100 MHz		1		220		IVII IZ

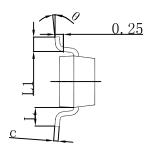


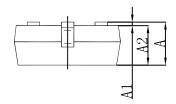
Typical Characteristics



SOT-23 Package Outline Dimensions

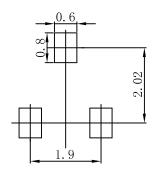






Symbol	Dimensions In Millimeters		Dimensions In Inches			
Symbol	Min	Max	Min	Max		
Α	0.900	1.150	0.035	0.045		
A1	0.000	0.100	0.000	0.004		
A2	0.900	1.050	0.035	0.041		
b	0.300	0.500	0.012	0.020		
С	0.080	0.150	0.003	0.006		
D	2.800	3.000	0.110	0.118		
E	1.200	1.400	0.047	0.055		
E1	2.250	2.550	0.089	0.100		
е	0.950	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079		
L	0.550 REF		0.022 REF			
L1	0.300	0.500	0.012	0.020		
θ	0°	8°	0°	8°		

SOT-23 Suggested Pad Layout



- Note: 1.Controlling dimension: in millimeters.
- 2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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